TOSHIBA Photocoupler GaAs IRED & Photo-MOS FET

TLP200D

PBX

Modem • Fax Card

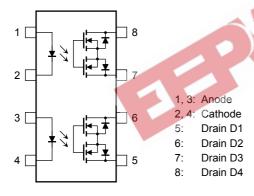
Measurement Instrument

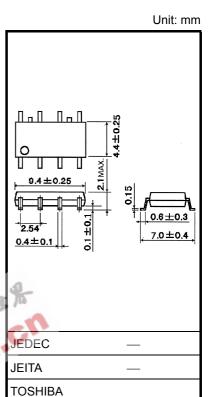
The TOSHIBA TLP200D consists of gallium arsenide infrared emitting diode optically coupled to a photo-MOS FET in an 8-pin SOP.

The TLP200D is a 2-form-A switch which is suitable for replacement of mechanical relays in many applications which require space savings.

- SOP 8 pin (2.54SOP8): 2-form-A
- Peak off-state voltage: 200 V (min)
- Trigger LED current: 3 mA (max)
- On-state current: 200 mA (max)
- On-state resistance: 8Ω (max)
- Isolation voltage: 1500 Vrms (min)
- UL recognized: UL1577, file No. E67349

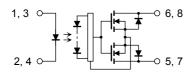
Pin Configurations (top view)

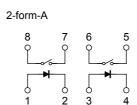




Weight: 0.2 g (typ.)

Schematic





Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
	Forward current	lF	50	mA
	Forward current derating (Ta ≥ 25°C)	ΔI _F /°C	-0.5	mA/°C
LED	Pulse forward current (100 μs pulse, 100 pps)	I _{FP}	1	А
	Reverse voltage	V _R	5	V
	Junction temperature	Tj	125	°C
Detector	Off-state output terminal voltage	V _{OFF}	200	V
	On-state current	I _{ON}	200	mA
	On-state RMS current derating (Ta ≥ 25°C)	Δl _{ON} /°C	-2.0	mA/°C
	Junction temperature	Tj	125	°C
Storage temperature range		T _{stg}	-55 to 125	°C
Operating temperature range		T _{opr}	-40 to 85	°C
Lead soldering temperature (10 s)		T _{sol}	260	°C
Isolation vo	oltage (AC, 1 min., R.H. ≤ 60%) (Note 1)	BVS	1500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Device considered a two-terminal device: Pins 1, 2, 3 and 4 shorted together and pins 5, 6, 7 and 8 shorted together

Note 2: Two channels operating simultaneously.

Recommended Operating Conditions

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	V_{DD}	_	150	200	V
Forward current	lF	5	7.5	25	mA
On-state current	I _{ON}	_	_	130	mA
Operating temperature	T _{opr}	-20	_	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Individual Electrical Characteristics (Ta = 25°C)

	Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
LED	Forward voltage	V_{F}	I _F = 10 mA	1.0	1.15	1.3	V
	Reverse current	I _R	$V_R = 5 V$			10	μΑ
	Capacitance	C _T	V = 0, $f = 1$ MHz		30		pF
Detector	Off-state current	l _{OFF}	V _{OFF} = 200 V			1	μΑ
	Capacitance	C _{OFF}	V = 0, $f = 1$ MHz		100		pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	I _{FT}	I _{ON} = 200 mA	_	1	3	mA
On-state resistance	R _{ON}	$I_{ON} = 200 \text{ mA}, I_F = 5 \text{ mA}$	_	5	8	Ω

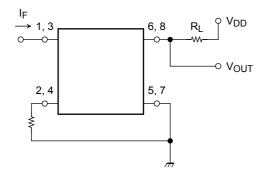
Isolation Characteristics (Ta = 25°C)

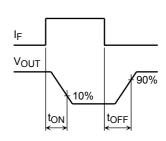
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	Cs	V _S = 0, f = 1 MHz	_	0.8	_	pF
Isolation resistance	R _S	V _S = 500 V, R.H. ≤ 60%	5 × 10 ¹⁰	10 ¹⁴	_	Ω
		AC, 1 minute	1500	_	_	Vrms
Isolation voltage	BVS	AC, 1 s, in oil	_	3000	_	VIIIIS
		DC, 1 minute, in oil	_	3000	_	Vdc

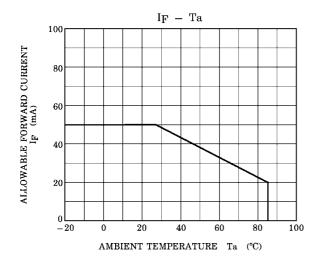
Switching Characteristics (Ta = 25°C)

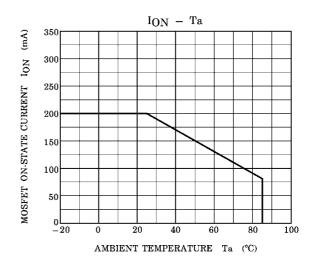
Characteristics	7	Symbol	Test Condition		Min	Тур.	Max	Unit
Turn-on time				(Note)		0.6	1.5	ms
Turn-off time		toff	$V_{DD} = 20 \text{ V}, I_F = 5 \text{ mA}$		_	0.1	1.0	ms

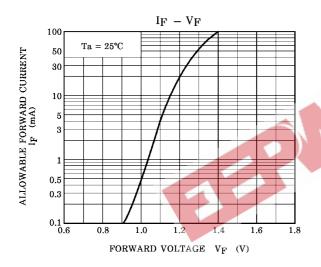
Note: Switching time test circuit

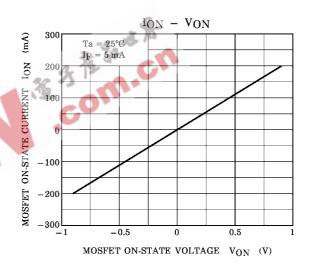


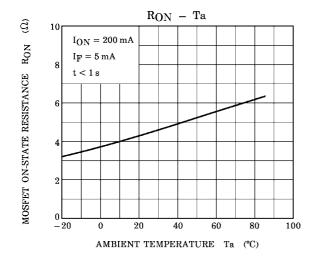


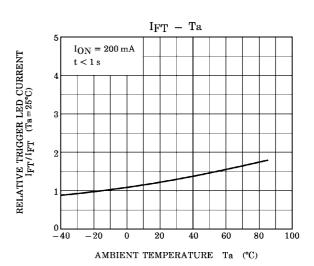


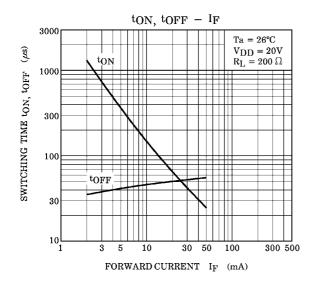


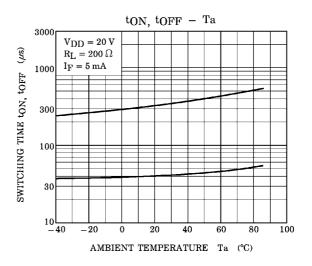


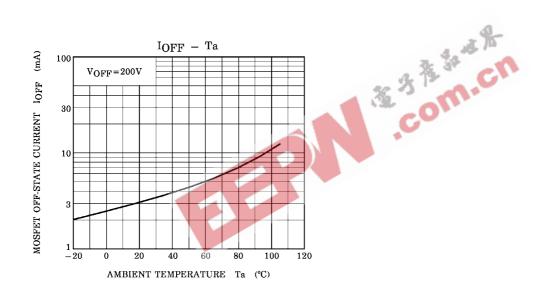












RESTRICTIONS ON PRODUCT USE

Handbook" etc.

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